

# **Specification for Approval**

Model Name:

Sı	upplier Approv	al	Customer approval
R&D Designed	R&D Approved	QC Approved	
Peter	Peng Jun		



# **Revision Record**

REV NO.	REV DATE	CONTENTS	Note
A	2020-03-12	NEW ISSUE	



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#### 1. Scope

This specification defines general provisions as well as inspection standards for TFT module supplied by AMSON electronics.

If the event of unforeseen problem or unspecified items may occur, naturally shall negotiate and agree to solution

#### 2. General Information

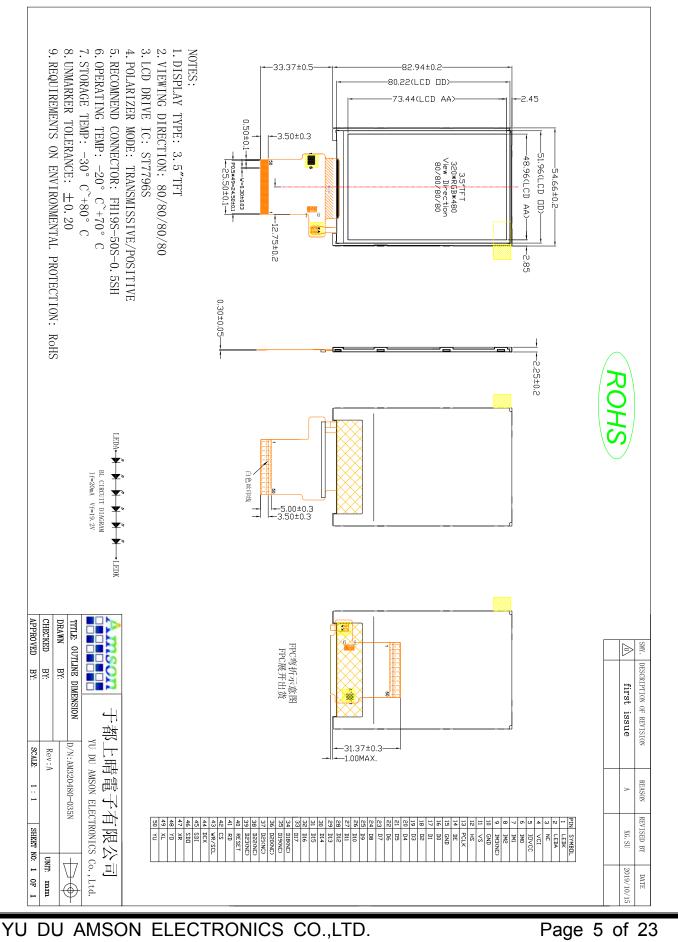
ITEM	STANDARD VALUES	UNITS
LCD type	3.5"TFT	
Dot arrangement	320(RGB)×480	dots
Color filter array	RGB vertical stripe	
Display mode	IPS / Transmission / Normally Black	-
Gray Scale Inversion Direction	80/80/80	
Eyes Viewing Direction	ALL	
Driver IC	ST7796S	
Module size	54.66(W)×82.94(H)×2.25(T)	mm
Active area	48.96(W)×73.44(H)	mm
Dot pitch	153(W)×153H)	um
Interface	MCU 8/9/16/18bit interface 3wrie/4wrie SPI+16/18bit RGB interface	
Operating temperature	-20 ~ +70	°C
Storage temperature	-30 ~ +80	°C
Back Light	6White LED	



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#### 3. External Dimensions





### 4. Interface Description

PIN NO.	PIN NAME	DESCRIPTION		
1	LEDK	The cathode of LED power		
2	LEDA	The Anode of LED power		
3	NC	NC		
4	VCI	Analog operating voltage.		
5	IOVCC	Logic operating voltage.		
6~8	IM0~IM2	MPU interface mode select pin,(FYI NOTE1)		
9	IM3	NC		
10	GND	Power ground		
11	VS	Frame synchronizing signal for RGB interface operation.		
12	HS	Line synchronizing signal for RGB interface operation.		
13	PCLK	Dot clock signal for RGB interface operation.		
14	DE	Data enable signal for RGB interface operation.		
15	GND	Power ground		
16-33	DB0-DB17	Data bus		
34`39	DB18~DB23	NC		
40	RESET	Reset pin setting either pin low initializes the LSI Must be reset after power supplied		
41	RD	Read signal input terminal, Active at 'L'.		
42	CS	Chip select signal input terminal, Active at 'L'		
43	WR/SCL	Serial clock input for SPI interface		
44	DCX	The SPI interface (DCX): The signal for command or parameter select.		
45	SDI	When IM [3]: Low, Serial in/out signal. When IM [3]: High, Serial input signal. The data is applied on the rising edge of the SCL signal.		
46	SDO	Serial output signal. The data is applied on the rising edge of the SCL signal.		
47	NC	NC		
48	NC	NC		
		NC		

YU DU AMSON ELECTRONICS CO., LTD.



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-								
	50	NC		NC				
No	ote1: The System interface mode select							
	IM2	IM1	IM	0	MPU Interface Mode	Data pin		
	0	0	0		8080 18-bit Interface	DB[17:0]		
	0	0	1		8080 9-bit Interface	DB[8:0]		
	0	1	0	0 8080 16-bit Interfac		DB[15:0]		
	0	1	1		8080 8-bit Interface	DB[7:0],		
	1	0	0	-	Reserve			
	1	0	1		3SPI	SDA, SDO		
	4	1	0		MIPI	MIPI_DATA		
		1	U		0		IVIIPI	MIPI_CLOCK
	1	1	1		4Line SPI	SDA, SDO		



#### 5. Absolute Maximum Ratings

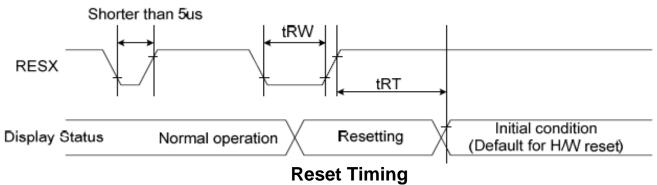
Item	Symbol	Min.	Max.	Unit
Logic Supply Voltage	IOVCC	-0.3	3.3	V
Analog Supply Voltage	VCI	-0.3	3.3	V
Input Voltage	Vin	-0.3	IOVCC+0.3	V
Operating Temperature	Тор	-20	70	°C
Storage Temperature	Tst	-30	80	°C
Storage Humidity	HD	20	90	%RH

#### 6. DC Characteristics

ltem	Symbol	Min.	Тур.	Max.	Unit	Remark
Logic Supply Voltage	IOVCC	1.65	1.8	3.3	V	-
Analog Supply Voltage	VCI	2.5	2.8	3.3	V	-
Input High Voltage	V <sub>IH</sub>	0.7*IOVCC	-	IOVCC	V	-
Input Low Voltage	V <sub>IL</sub>	-0.3	-	0.3*IOVCC	V	-
Output High Voltage	V <sub>OH</sub>	0.8*IOVCC	-	IOVCC	V	-
Output Low Voltage	V <sub>OL</sub>	GND	-	0.2*IOVCC	V	-
I/O Leak Current	LI	-1	-	1	uA	-



# 7. Timing Characteristics7.1 Reset Timing Characteristics



Signal	Symbol	Parameter	Min	Мах	Unit
	tRW	Reset pulse duration	10		uS
RESX	4DT	Deast series		5 (note 1,5)	mS
	tRT Reset cancel		120 (note 1,6,7)	mS	

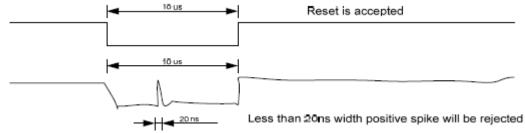
#### Notes:

- 1. The reset cancel also includes the required time for loading ID bytes, VCOM setting and other settings from the EEPROM to registers. After a rising edge of RESX, this loading is done within 5 ms after the H/W reset cancel (tRT).
- 2. According to the Table 40, a spike due to an electrostatic discharge on the RESX line does not cause irregular system reset.

|--|

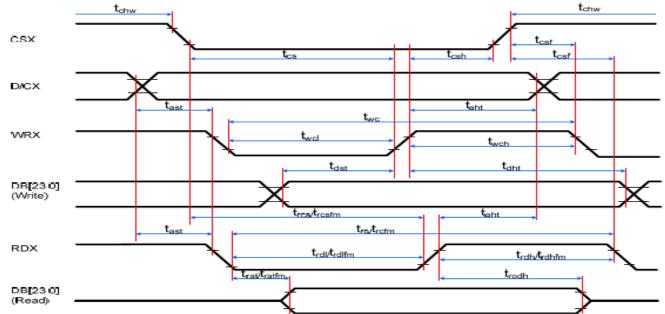
RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 9us	Reset
Between 5us and 9us	Reset starts

- During the Reset period, the display will be blanked (When Reset starts in the Sleep Out mode, the display will enter the blanking sequence in at least 120 ms. The display remains the blank state in the Sleep In mode.) and then return to the default condition for the Hardware Reset.
   Drive Deisetion can also be applied during a walld search available as above below.
- 4. Spike Rejection can also be applied during a valid reset pulse, as shown below:



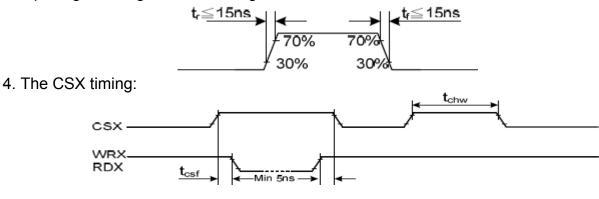


#### 7.2 MCU 8/9/16/18-bit Timing Characteristics



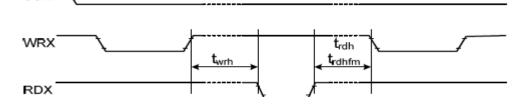
Signal	Symbol	Parameter	min	max	Unit	Description	
DCX	tast	Address setup time	0	-	ns	-	
DCX	that	Address hold time (Write/Read)	0	-	ns	-	
	tchw	CSX "H" pulse width	0	-	ns	-	
	tcs	Chip Select setup time (Write)	15	-	ns	-	
CSX	trcs	Chip Select setup time (Read ID)	45	-	ns	-	
	trcsfm	Chip Select setup time (Read FM)	355	-	ns	-	
	tcsf	Chip Select Wait time (Write/Read)	0	-	ns	-	
	twc	wc Write cycle 30 -	ns	-			
WBX	twrh	Write Control pulse H duration	15	-	ns	-	
		ns	-				
	trcfm	Read Cycle (FM)	450	-	ns	When read from Frame Memory	
RDX (FM)	trdhfm	Read Control H duration (FM)	90	-	ns		
	trdlfm	Read Control L duration (FM)	355	-	ns		
	trc Read cycle (ID)		160	-	ns		
RDX (ID)	trdh	Read Control pulse H duration	90	-	ns	When read ID data	
	trdl	Read Control pulse L duration	45	-	ns		
DB [23:0],	tdst	Write data setup time	10	-	ns		
DB [23:0], DB [17:0],	tdht	Write data hold time	10	-	ns		
DB [15:0],	trat	Read access time	-	40	ns	For maximum, CL=30pF For minimum, CL=8pF	
DB [8:0],	tratfm	Read access time	-	340	ns		
DB [7:0]	trod	Read output disable time	20	80	ns	1	

- 1. Ta = -30 to 70 °C, IOVCC = 1.65V to 3.3V, VCI = 2.5V to 3.3V, AGND = DGND = 0V
- 2. Logic high and low levels are specified as 30% and 70% of IOVCC for input signals.
- 3. Input signal rising time and falling time:





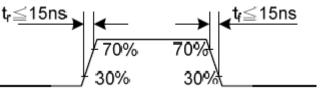
5. The Write to Read or the Read to Write timing: csx



#### 7.3 Display Serial Interface Timing Characteristics

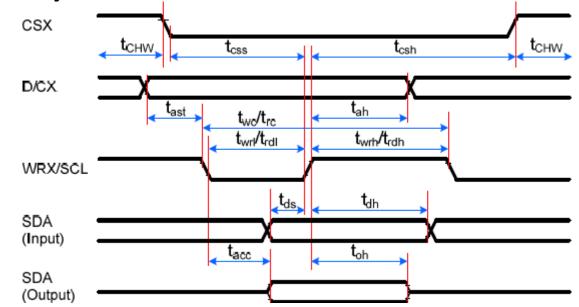
#### 3-wrie SPI system CSX t<sub>css</sub> tchw t<sub>CHW</sub> $t_{csh}$ two/trc t<sub>sc</sub> t<sub>wri</sub>/t<sub>rdi</sub> t<sub>wrh</sub>/t<sub>rdh</sub> WRX/SCL t<sub>ds</sub> t<sub>dh</sub> SDA (Input) t<sub>acc</sub> t<sub>oh</sub> SDA Hi-Z Hi-Z (Output) Signal Symbol Unit Description Parameter min max tsc SCL-CSX 15 ns CSX H Pulse Width 40 tchw ns CSX tcss Chip select time (Write) 60 ns tcsh Chip select hold time (Read) 65 ns . twc Serial Clock Cycle (Write) 66 . ns twrh SCL H Pulse Width (Write) 15 ns \_ twrl SCL L Pulse Width (Write) 15 ns . SCL 150 Serial Clock Cycle (Read) trc ns trdh SCL H Pulse Width (Read) 60 . ns SCL L Pulse Width (Read) 60 trdl ns tds Data setup time (Write) 10 SDA/SDI ns (Input) Data hold time (Write) tdh 10 ns SDA/SDO tacc Access time (Read) 10 50 ns For maximum CL=30pF (Output) For minimum CL=8pF toh Output disable time (Read) 15 50 ns

Note: Ta = -30 to 70 °C, IOVCC = 1.65V to 3.6V, VCI = 2.5V to 3.6V, AGND = DGND = 0V, T = 10+/-0.5ns





#### 4-wrie SPI system



Signal	Symbol	Parameter	min	max	Unit	Description
	tcss	Chip select time (Write)		-	ns	
CSX	tcsh	Chip select hold time (Read)	15	-	ns	
	tCHW	CS H pulse width	40	-	ns	
	twc	Serial clock cycle (Write)	50	-	ns	
	twrh	SCL H pulse width (Write)	10	-	ns	
SCL	twrl	SCL L pulse width (Write)	10	-	ns	
SOL	trc	Serial clock cycle (Read)	150	-	ns	
	trdh	SCL H pulse width (Read)	60	-	ns	
	trdl	SCL L pulse width (Read)			ns	
DIOX	tas	D/CX setup time	10	-	ns	
D/CX	tah	D/CX hold time (Write/Read)	10	-	ns	
SDA/SDI	tds	Data setup time (Write)	10	-	ns	
(Input)	tdh	Data hold time (Write)	10	-	ns	
SDA/SDO	tacc	Access time (Read)	10	50	ns	For maximum CL=30pF
(Output)	tod	Output disable time (Read)	15	50	ns	For minimum CL=8pF

#### Notes:

1. Ta = -30 to 70 °C, IOVCC = 1.65V to 3.3V, VCI = 2.5V to 3.3V, AGND = DGND = 0V, T = 10+/-0.5ns.

2. Does not include signal rising and falling times.



#### **t**SYNCS trgb<u>f</u> trgbr VSYNC Vін HSYNC tens tenn Ин νн ENABLE Vii trgbf trgbr PWDL PWDH νн νін Ин DOTCLK Vι toyod tPDS **t**PDH Vін Ин DB[17:0] Write Data Vii Vii Signal Symbol Parameter min max Unit Description VSYNC/HSYNC setup time 15 ns VSYNC/ tsyncs \_ HSYNC VSYNC/HSYNC hold time 15 ns tsynch . ENABLE setup time 15 tens \_ ns ENABLE 15 ENABLE hold time t<sub>ENH</sub> . ns 15 t<sub>POS</sub> Data setup time . ns 16-/18-/24-bit bus DB [23:0] RGB interface mode t<sub>PDH</sub> Data hold time 15 ns . PWDH DOTCLK high-level period 20 \_ ns PWDL DOTCLK low-level period 20 ns DOTCLK 50 tcyco DOTCLK cycle time ns t<sub>rgbr</sub>, t<sub>rgbf</sub> DOTCLK,HSYNC,VSYNC rise/fall time 15 ns Note: Ta = -30 to 70 ℃, IOVCC = 1.65V to 3.3V, VCI = 2.5V to 3.3V, AGND = DGND = 0V t<sub>f</sub>≦15ns t<sub>r</sub>≦15ns , 70% 70%

30%

30%

#### 7.4 Parallel 18/16-bit RGB Interface Timing Characteristics



### 8. Backlight Characteristics



#### **BL CIRCUIT DIAGRAM**

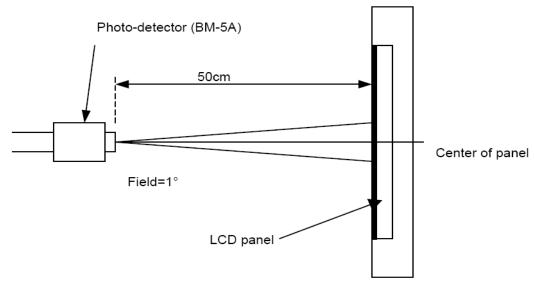
Item	Symbol	MIN	ТҮР	MAX	UNIT	<b>Test Condition</b>
Supply Voltage	Vf	16.8	19.2	21	V	lf=20mA
Supply Current	lf	-	20	-	mA	-
Luminous Intensity for LCM	-	250	300	-	cd/m <sup>2</sup>	lf=20mA
Uniformity for LCM	-	80	-	-	%	lf=20mA
Life Time	-	-	50000	-	Hr	lf=20mA
Backlight Color	White					



#### 9. Optical Characteristics

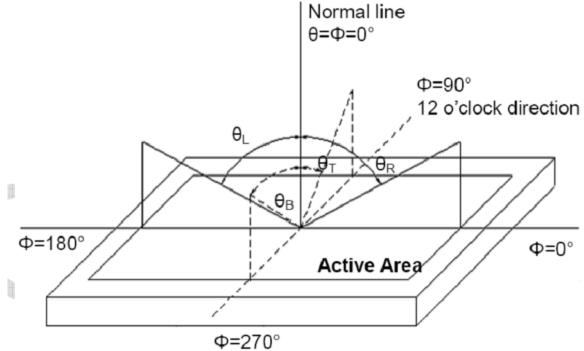
Item	Condition	Min.	Тур.	Max.	Unit	Note		
		θL	_	80	_			
Viewing Angle	Horizontal	θR	-	80	-			
(CR>10)	Vortical	θт	-	80	-	degree	(1),(2),(6)	
	Vertical	θв	-	80	-			
Contrast Ratio	Center		-	700	-	-	(1),(3),(6)	
Response Time	Rising + Fal	ling	-	30	-	ms	(1),(4),(6)	
	Red x			TBD		-		
	Red y			TBD		-		
	Green x			TBD		-		
CF Color	Green y		Тур.	TBD	Тур.	-	(1) (6)	
Chromaticity (CIE1931)	Blue x		-0.05	TBD	+0.05	-	(1), (6)	
	Blue y			TBD		-		
	White x			TBD	]	-		
	White y	White y		TBD		-		

Note (1) Measurement Setup: The LCD module should be stabilized at given temp. 25°C for 15 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting backlight for 15 minutes in a windless room.





#### Note (2) Definition of Viewing Angle

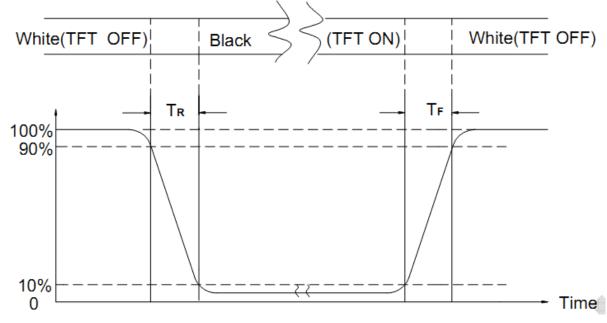


Note (3) Definition Of Contrast Ratio (CR)

The contrast ratio can be calculated by the following expression Contrast Ratio (CR) = L63 / L0

L63: Luminance of gray level 63, L0: Luminance of gray level 0

Note (4) Definition of response time



Note (5) Definition of Transmittance (Module is without signal input) Transmittance = Center Luminance of LCD / Center Luminance of Back Light x 100%

Note (6) Definition of color chromaticity (CIE1931)

Color coordinates measured at the center point of LCD



#### 10. Reliability Test Conditions and Methods

NO.	TEST ITEMS	TEST CONDITION	INSPECTION AFTER TEST
	High Temperature Storage	80°C±2°C×96Hours	
	Low Temperature Storage	-30°C±2°C×96Hours	
	High Temperature Operating	70°C±2°C×96Hours	
	Low Temperature Operating	-20°C±2°C×96Hours	Inspection after 2~4hours storage at room temperature, the samples
	Temperature Cycle(Storage)	$\begin{array}{cccc} -20^{\circ}\text{C} & \longleftrightarrow & 25^{\circ}\text{C} & \longleftrightarrow & 70^{\circ}\text{C} \\ (30\text{min}) & (5\text{min}) & (30\text{min}) \\ & & 1\text{cycle} \\ & & \text{Total 10cycle} \end{array}$	should be free from defects: 1, Air bubble in the LCD. 2, Seal leak. 3, Non-display.
	Damp Proof Test (Storage)	50°C±5°C×90%RH×96Hours	4, Missing segments. 5, Glass crack. 6, Current IDD is twice
	Vibration Test	Frequency:10Hz~55Hz~10Hz Amplitude:1.5MM X,Y,Z direction for total 3hours (packing condition test will be tested by a carton)	higher than initial value. 7, The surface shall be free from damage. 8, The electric characteristic requirements shall be satisfied.
	Drooping Test	Drop to the ground from 1M height one time every side of carton. (packing condition test will be tested by a carton)	
	ESD Test	Voltage:±8KV,R:330Ω,C:150PF,Air Mode,10times	

REMARK:

1, The Test samples should be applied to only one test item.

2, Sample side for each test item is 5~10pcs.

3,For Damp Proof Test, Pure water(Resistance >  $10M\Omega$ )should be used.

4, In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judge as a good part.

5, EL evaluation should be accepted from reliability test with humidity and temperature: Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and Fluorescence EL has.

6, Failure Judgment Criterion: Basic Specification Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.



#### 11. Inspection Standard

#### 11.1. QUALITY :

THE QUALITY OF GOODS SUPPLIED TO PURCHASER SHALL COME UP TO THE FOLLOWING STANDARD. 11.1.1. THE METHOD OF PRESERVING GOODS

AFTER DELIVERY OF GOODS FROM AMSON TO PURCHASER. PURCHASER SHALL CONTROL THE LCM AT -10 °C TO 40 °C , AND IT MIGHT BE DESIRABLE TO KEEP AT THE NORMAL ROOM TEMPERATURE AND HUMIDITY UNTIL INCOMING INSPECTION OR THROWING INTO PROCESS LINE.

#### 11.1.2. INCOMING INSPECTION

(A) THE METHOD OF INSPECTION

IF PURCHASER MAKE AN INCOMING INSPECTION, A SAMPLING PLAN SHALL BE APPLIED ON THE CONDITION THAT QUALITY OF ONE DELIVERY SHALL BE REGARDED AS ONE LOT.

(B) THE STANDARD OF QUALITY

ISO-2859-1 (SAME AS MIL-STD-105E), LEVEL II SINGLE PLAN.

CLASS	AQL(%)
CRITICAL	0.4 %
MAJOR	0.65 %
MINOR	1.5 %
TOTAL	1.5 %

EVERY ITEM SHALL BE INSPECTED ACCORDING TO THE CLASS.

(C) MEASURE

IF AS THE RESULT OF ABOVE RECEIVING INSPECTION, A LOT OUT IS DISCOVERED. PURCHASER SHALL BE INFORM SELLER OF IT WITHIN SEVEN DAYS. BUT FIRST SHIPMENT WITHIN FOURTEEN DAYS.

#### 11.1.3. WARRANTY POLICY

AMSON WILL PROVIDE ONE-YEAR WARRANTY FOR THE PRODUCTS ONLY IF UNDER SPECIFICATION OPERATING CONDITIONS. AMSON WILL REPLACE NEW PRODUCTS FOR THESE DEFECT PRODUCTS WHICH UNDER WARRANTY PERIOD AND BELONG TO THE RESPONSIBILITY OF AMSON.

- 11.2. CHECKING CONDITION
- 11.2.1. CHECKING DIRECTION SHALL BE IN THE 45 DEGREE AREA TO FACE THE SAMPLE.
- 11.2.2. CHECKER SHALL SEE OVER 300±25 mm. WITH BARE EYES FAR FROM SAMPLE AND USING 2 PCS. OF 20W FLUORESCENT LAMP.



#### 11.3. INSPECTION PLAN :

CLASS	ITEM	JUDGEMENT	CLASS
	1. OUTSIDE AND INSIDE PACKAGE	"MODEL NO.", "LOT NO." AND "QUANTITY"	Minor
PACKING &		SHOULD INDICATE ON THE PACKAGE.	
INDICATE	2. MODEL MIXED AND QUANTITY	OTHER MODEL MIXEDREJECTED	Critical
		QUANTITY SHORT OR OVER REJECTED	
	3. PRODUCT INDICATION	"MODEL NO." SHOULD INDICATE ON	Major
		THE PRODUCT	
	4. DIMENSION,	ACCORDING TO SPECIFICATION OR	
ASSEMBLY	LCD GLASS SCRATCH	DRAWING.	Major
	AND SCRIBE DEFECT.		
	5. VIEWING AREA	POLARIZER EDGE OR LCD'S SEALING LINE	Minor
		IS VISABLE IN THE VIEWING AREA	
		REJECTED	
	6. BLEMISH \ BLACK SPOT \	ACCORDING TO STANDARD OF VISUAL	Minor
	WHITE SPOT IN THE LCD	INSPECTION(INSIDE VIEWING AREA)	
	AND LCD GLASS CRACKS		
	7. BLEMISH SLACK SPOT	ACCORDING TO STANDARD OF VISUAL	Minor
APPEARANCE	WHITE SPOT AND SCRATCH	INSPECTION(INSIDE VIEWING AREA)	
	ON THE POLARIZER		
	8. BUBBLE IN POLARIZER	ACCORDING TO STANDARD OF VISUAL	Minor
		INSPECTION(INSIDE VIEWING AREA)	
	9. LCD'S RAINBOW COLOR	STRONG DEVIATION COLOR ( OR NEWTON	
		RING) OF LCD REJECTED.	Minor
		OR ACCORDING TO LIMITED SAMPLE	
		( IF NEEDED, AND INSIDE VIEWING AREA )	
	10. ELECTRICAL AND OPTICAL	ACCORDING TO SPECIFICATION OR	Critical
	CHARACTERISTICS	DRAWING . ( INSIDE VIEWING AREA )	ondoar
	(CONTRAST, VOP,		
	CHROMATICITY ETC )		
ELECTRICAL	11.MISSING LINE	MISSING DOT . LINE . CHARACTER	Critical
		REJECTED	ontical
	12.SHORT CIRCUIT	NO DISPLAY VIENONG PATTERN	Critical
	WRONG PATTERN DISPLAY		ontical
		OUT OF SPECIFICATION REJECTED	
			Minor
	13. DOT DEFECT (FOR COLOR AND TFT)	ACCORDING TO STANDARD OF VISUAL	MINO
		INSPECTION	



#### 11.4. STANDARD OF VISUAL INSPECTION

NO.	CLASS	ITEM	JUDGEMENT					
			(A) ROUND TYPE: unit : mm.					
			DIAMETER (mm.) ACCEPTABLE Q'TY					
			$\Phi \leq 0.1$ DISREGARD					
			$0.1 < \Phi \leq 0.25$ 3 (Distance>5mm)					
		BLACK AND WHITE SPOT	0.25 < Φ 0					
11 4 1	MINOR	FOREIGN MATERIEL DUST IN THE CELL	NOTE: $\Phi = (\text{LENGTH} + \text{WIDTH})/2$					
11.4.1	MINON	BLEMISH	(B) LINEAR TYPE: unit : mm.					
		SCRATCH	LENGTH WIDTH ACCEPTABLE Q'TY					
			W ≦0.03 DISREGARD					
			L ≦ 5.0 0.03 < W ≦0.07 3 (Distance>5mm)					
			0.07 < W FOLLOW ROUND TYPE					
$\vdash$								
			Unit : mm. DIAMETER ACCEPTABLE Q'TY					
		BUBBLE IN POLARIZER DENT ON POLARIZER	$\Phi \leq 0.2  \text{DISREGARD}$					
11.4.2	MINOR		$0.2 < \Phi \leq 0.5$ 2 (Distance>5mm)					
			$0.5 < \Phi$ 0					
		Dot Defect	Items ACC. Q'TY					
			Bright dot N≦ 4					
			Dark dot N≦ 4					
			Bind Define (					
			Pixel Define : Pixel					
11.4.3	MINOR							
			← Dot →← Dot →					
			Note 1: The definition of dot: The size of a defective dot over					
			1/2 of whole dot is regarded as one defective dot.					
			Note 2: Bright dot: Dots appear bright and unchanged in size					
			in which LCD panel is displaying under black pattern.					
			Note 3: Dark dot: Dots appear dark and unchanged in size in					
			which LCD panel is displaying under pure red, green					
			,blue pattern.					



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NO.	CLASS	ITEM	JUDGEMEN	Т
11.4.4	MINOR	LCD GLASS CHIPPING	S S	Y > S Reject
11.4.5	MINOR	LCD GLASS CHIPPING	S X S	X or Y > S Reject
11.4.6	MAJOR	LCD GLASS GLASS CRACK	Y Y	Y > (1/2) T Reject
11.4.7	MAJOR	LCD GLASS SCRIBE DEFECT	$\Lambda_{\tau \vdash a \dashv}^{\pm} B$	<ol> <li>a&gt; L/3, A&gt;1.5mm. Reject</li> <li>B: ACCORDING TO DIMENSION</li> </ol>
11.4.8	MINOR	LCD GLASS CHIPPING ( ON THE TERMINAL AREA )	T	$\Phi = (x+y)/2 > 2.5 \text{ mm}$ Reject
11.4.9	MINOR	LCD GLASS CHIPPING ( ON THE TERMINAL SURFACE )	T Z X	Y > (1/3) T Reject
11.4.10	MINOR	LCD GLASS CHIPPING	X -> -y Z	Y > T Reject

#### **12. Handling Precautions**

#### 12.1 Mounting method

The LCD panel of AMSON TFT module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

#### 12.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent

[Recommended below] and wipe lightly

- Isopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water
- Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns Do not use the following solvent on the pad or prevent it from being contaminated:

- Soldering flux
- Chlorine (CI) , Sulfur (S)

If goods were sent without being silicon coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Sulfur (S) from customer, Responsibility is on customer.

#### 12.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you:

Connect any unused input terminal to VDD or GND, do not input any signals before power is turned on, and ground your body, work/assembly areas, and assembly equipment to protect against static electricity.

#### 12.4 packing

- Module employs LCD elements and must be treated as such.
- Avoid intense shock and falls from a height.
- To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity

#### 12.5 Caution for operation

- It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.
- An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.
- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- Slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.

Usage under the maximum operating temperature, 50%Rh or less is required.



#### 12.6 storing

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

- Storage in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it. And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- Storing with no touch on polarizer surface by the anything else. [It is recommended to store them as they have been contained in the inner container at the time of delivery from us

#### 12.7 Safety

- It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water

#### **13. Precaution for Use**

#### 13.1

A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

#### 13.2

On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

- When a question is arisen in this specification
- When a new problem is arisen which is not specified in this specifications
- When an inspection specifications change or operating condition change in customer is reported to AMSON TFT , and some problem is arisen in this specification due to the change
- When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

#### 14. Packing Method

#### TBD